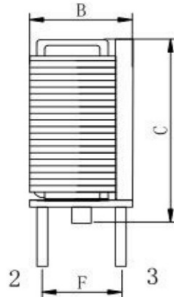
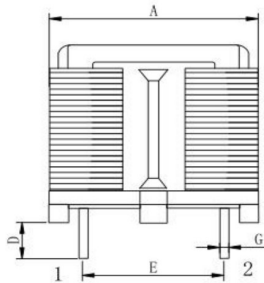


DIMENSION:(UNIT:mm)

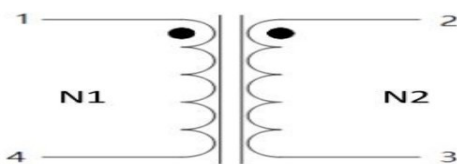


A	15.0 MAX
B	9.0 MAX
C	14.0 MAX
D	3.3±0.5
E	7.0±0.5
F	5.8±0.5
G	0.7±0.1



AC 1000V	COIL-COIL
AC 500V	COIL-CORE

SCHEMATICS:



ELECTRONICAL CHARACTERISTIC

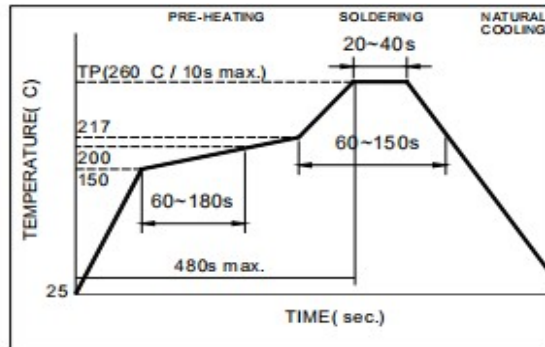
ITEM	SPEC.	TEST FRE.
L	10mH MIN	1KHZ/0.25V
RDC	200mΩ MAX	25°C
IDC	0.6~0.8A	1KHZ/0.25V
	ΔT≤40°C TYP	1KHZ/0.25V
Test Internal Resistance 20 Ω		

MAIN MATERIALS LIST:

NO	DESCRIPTION	MATERIAL
1	WIRE	SFT-UEWJ180°C 0.1*0.7*36 TS(REF)
2	DR CORE	Mn-Zn Painting
3	RI CORE	无
4	BASE/CLIP	T375HF 150°C
5	EPOXY	无

**SOLDERING CONDITIONS**

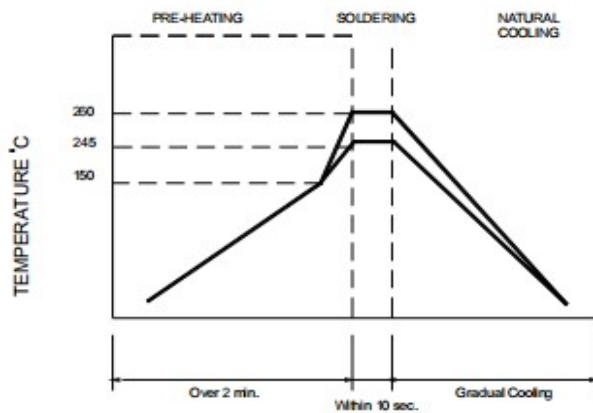
**Figure 1.  
Re-flow  
Soldering (Lead  
Free)**



Note:

- Preheat circuit and products to 150°C
- 260°C tip temperature (max)
- Reflow times: no more than 2 times
- Solder paste thickness: the best 0.08mm is ,but max is 0.1mm

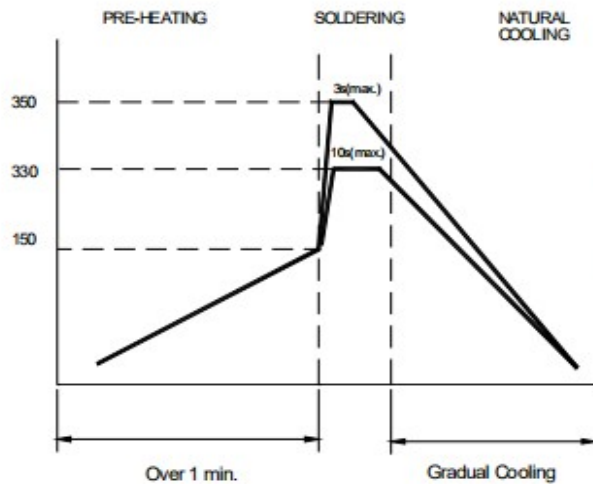
**Figure 2.  
Wave Soldering**



Note :

- Never contact the ceramic with the iron tip
- 1.0mm tip diameter (max)

**Figure 3.  
Hand Soldering**



Note:

- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limit soldering time to 3 sec.